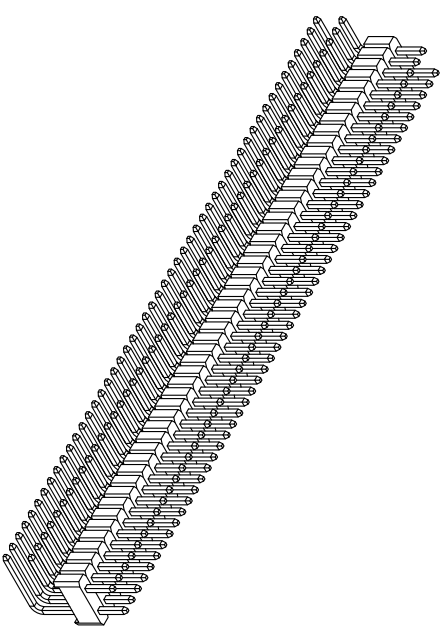
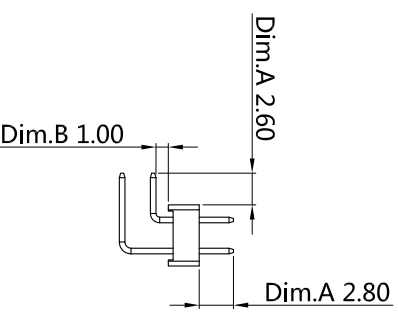
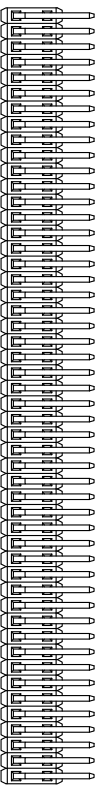
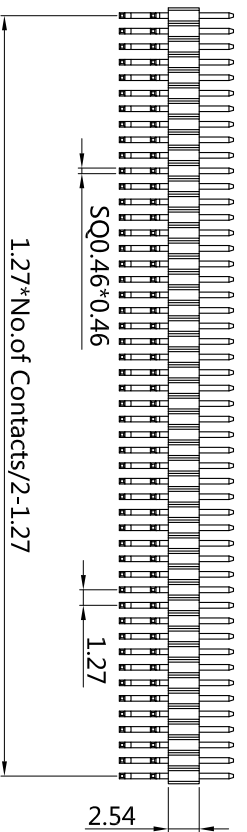
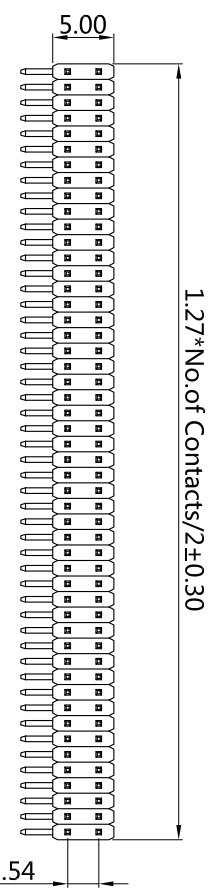


1 2 3 4 5 6 7 8

A



Current Rating: 1 Amps
 Insulator Resistance: 1000 Megohms min
 Dielectric Withstanding: AC 300V
 Contact Resistance: 20mΩ MAX
 Operation Temperature: -40~+105°C
 Max processing temp: 230°C for 60seconds
 Max processing temp: 260°C for 10seconds
 Contact Material: Brass
 Insulator material: Standard: Polyester, UL 94V-0
 Standard: PA6T
 Finish: Tin Gold Plated
 Standard: Gold Flash all over

(RoHS Compliant) H4 X 25 - 2 XX R0 BK X 000 X

1. Insulator material: 5. Contact Plated:
 N=PA6T T=Matte Tin over Nickel
 L=LCP P=PA9T W=Matte Tin over nickel 150μ"
 Y=Bright Tin over Nickel G=Gold 10μ"
 F= Gold Flash, Matte Tin 100μ" J=Gold 10μ"
 A=Gold 3μ" L= Gold 15μ"
 R0=90° B=Gold 3μ" M=Gold 15μ"
 C = ordinary gold plating U= Gold 30μ"
 D= Gold 5μ" V=Gold 30μ" Matte Tin 100μ"

6.Special Options

7. Packing:

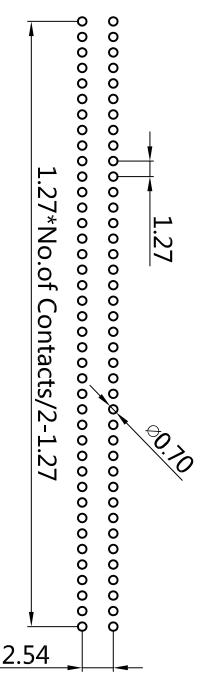
A=Bag
 B=Tube
 D=Small box
 E=Cap+Reel

F
 1. Insulator material:
 2. Circuits:
 3. Tail Style:
 4. Color:
 BK=Black



东莞市震升电子有限公司
 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD

Recommended P.C. Board
 SMD Layout



BOM	1: H4N25-250BKHC4	DRAWING NO	ZS-00202-P	EDITION:A1	ITEM: H4
	2: SQ0.46-10.2/15.2-X-C12	DRAWN BY	Deng jin quan	2021-12-22	SCALE:1:1
	3:	APPROVAL BY	Chen xiao guang	2021-12-23	UNIT:M.M

PART NO.	H4X25-2XXR0BKX000X	X	.XX	.XXX
		±0.30	±0.20	±0.1

1 2 3 4 5 6 7 8